

10/7/2004

	Type	Ref #	Hits	Search Text	DBs
1	IS&R	S1	5	("20040216475").PN.	US - PGPUB; USPAT; EPO; JPO; DERWENT
2	BRS	S2	1252	chiller and substrate	US - PGPUB; USPAT; EPO; JPO; DERWENT
3	BRS	S3	578	S2 and (flow adj rate)	US - PGPUB; USPAT; EPO; JPO; DERWENT
4	BRS	S4	21	S3 and idle	US - PGPUB; USPAT; EPO; JPO; DERWENT
5	BRS	S5	2535	chiller and (flow adj rate)	US - PGPUB; USPAT; EPO; JPO; DERWENT
6	BRS	S6	100	S5 and idle	US - PGPUB; USPAT; EPO; JPO; DERWENT
7	BRS	S7	28	S6 and "62"/\$.ccls.	US - PGPUB; USPAT; EPO; JPO; DERWENT
8	BRS	S8	590	S5 and "62"/\$.ccls.	US - PGPUB; USPAT; EPO; JPO; DERWENT
9	BRS	S9	51	S8 and (semiconductor or (semi adj conductor))	US - PGPUB; USPAT; EPO; JPO; DERWENT
10	IS&R	S10	374	(62/185).CCLS.	US - PGPUB; USPAT; EPO; JPO; DERWENT
11	IS&R	S11	399	(62/201).CCLS.	US - PGPUB; USPAT; EPO; JPO; DERWENT
12	IS&R	S12	755	(62/180).CCLS.	US - PGPUB; USPAT; EPO; JPO; DERWENT
13	IS&R	S13	516	(62/157).CCLS.	US - PGPUB; USPAT; EPO; JPO; DERWENT
14	IS&R	S14	728	(62/259.2).CCLS.	US - PGPUB; USPAT; EPO; JPO; DERWENT
15	IS&R	S15	50	(165/268).CCLS.	US - PGPUB; USPAT; EPO; JPO; DERWENT

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16	BRS	S16	2633	S10 or S11 or S12 or S13 or S14 or S15	US-PGPUB; USPAT; EPO; JPO; DERWENT
17	BRS	S17	2807715	(semiconductor or (semi adj conductor) or substrate or wafer)	US-PGPUB; USPAT; EPO; JPO; DERWENT
18	BRS	S18	401	S16 and S17	US-PGPUB; USPAT; EPO; JPO; DERWENT
19	BRS	S19	151	S18 and (flow adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT
20	BRS	S20	19	S18 and ((flow adj rate) with coolant)	US-PGPUB; USPAT; EPO; JPO; DERWENT
21	BRS	S21	1	S20 and chiller	US-PGPUB; USPAT; EPO; JPO; DERWENT
22	BRS	S22	18	S19 and chiller	US-PGPUB; USPAT; EPO; JPO; DERWENT
23	BRS	S23	32	S18 and chiller	US-PGPUB; USPAT; EPO; JPO; DERWENT
24	IS&R	S24	451	(361/688) .CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT
25	IS&R	S25	392	(361/689) .CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT
26	IS&R	S26	790	(361/699) .CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT
27	IS&R	S27	190	(361/701) .CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT
28	BRS	S28	1574	S24 or S25 or S26 or S27	US-PGPUB; USPAT; EPO; JPO; DERWENT
29	BRS	S29	760	S28 and S17	US-PGPUB; USPAT; EPO; JPO; DERWENT
30	BRS	S30	164	S29 and (flow adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT

	Type	Ref #	Hits	Search Text	DBs
31	BRS	S31	53	S29 and ((flow adj rate) with coolant)	US-PGPUB; USPAT; EPO; JPO; DERWENT
32	BRS	S32	0	S31 and idle	US-PGPUB; USPAT; EPO; JPO; DERWENT
33	BRS	S33	3	S31 and chiller	US-PGPUB; USPAT; EPO; JPO; DERWENT
34	BRS	S34	0	S32 and chiller	US-PGPUB; USPAT; EPO; JPO; DERWENT
35	BRS	S35	9	S30 and chiller	US-PGPUB; USPAT; EPO; JPO; DERWENT
36	BRS	S36	28	S30 and "62"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT
37	BRS	S37	9	S31 and "62"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT
38	BRS	S38	9	("20020000198"   "5376213"   "5761023"   "5835334"   "6086952"   "6182602"   "6189483"   "6286451"   "6320737").PN.	US-PGPUB; USPAT; USOCR
39	BRS	S39	0	("6684652").URPN.	USPAT
40	BRS	S40	113	S29 and ((flow adj rate) with cool\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT
41	BRS	S41	0	S40 and idle	US-PGPUB; USPAT; EPO; JPO; DERWENT
42	BRS	S42	4	S40 and chiller	US-PGPUB; USPAT; EPO; JPO; DERWENT
43	BRS	S43	94	S28 and S16	US-PGPUB; USPAT; EPO; JPO; DERWENT
44	BRS	S44	25	S43 and ((flow adj rate) with cool\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT
45	BRS	S45	2	S44 and chiller	US-PGPUB; USPAT; EPO; JPO; DERWENT

	Type	Ref #	Hits	Search Text	DBs
46	BRS	S46	27	S28 and chiller	US - PGPUB; USPAT; EPO; JPO; DERWENT
47	BRS	S47	4113	S28 or S16	US - PGPUB; USPAT; EPO; JPO; DERWENT
48	BRS	S48	1453566	(semiconductor or (semi adj conductor) and wafer)	US - PGPUB; USPAT; EPO; JPO; DERWENT
49	BRS	S49	252152	(semiconductor or (semi adj conductor)) and wafer	US - PGPUB; USPAT; EPO; JPO; DERWENT
50	BRS	S50	125	S47 and S49	US - PGPUB; USPAT; EPO; JPO; DERWENT
51	BRS	S51	10	S50 and chiller	US - PGPUB; USPAT; EPO; JPO; DERWENT
52	BRS	S52	9	S51 and flow	US - PGPUB; USPAT; EPO; JPO; DERWENT
53	BRS	S53	5	S51 and (flow adj rate)	US - PGPUB; USPAT; EPO; JPO; DERWENT